

Product Change Notice (PCN)

Subject: Site addition of package assembly, and final test Publication Date: 10/30/2023 Effective Date: 2/9/2024

Revision Description:

Initial release

Description of Change:

Renesas plans to add the site of assembly/final test for RZ/T2L to realize stable supply. Renesas would like to deliver products produced in the added site for your orders.

Items	Additional site	Current site
ASSY	Advanced Semiconductor Engineering, Inc.	Siliconware Precision Industries Co., LTD. (SPIL)
	(ASE-KH)	
FT	TeraPower Technology Inc.	King Yuan ELECTRONICS CO., LTD. (KYEC)

Affected Product List:

R9A07G074M08GBG#AC0 R9A07G074M05GBG#AC0 R9A07G074M04GBG#AC0 R9A07G074M01GBG#AC0

Reason for Change:

For stable supply of products.

Impact on Fit, Form, Function, Quality & Reliability:

No impact on the fit, form, function, quality, and reliability.

Product Identification:

The assembly site can be identified through the lot number of package marking. Please refer to the Appendix in details.

Qualification Status: Completed. The reliability report can be gotten on RZ/T2L website.

Sample Availability Date: Available

Device Material Declaration: Available upon request



Note:

- 1. Acknowledgement must be received by Renesas within 30 days or Renesas will consider the change as approved.
- If timely acknowledgement is provided by Customer, then Customer shall have 90 days from the date of receipt of this PCN to make any objections to this PCN. If Customer fails to make objections to this PCN within 90 days of the receipt of the PCN then Renesas will consider the PCN changes as approved.
- 3. If customer cannot accept the PCN then customer must provide Renesas with a last time buy demand and purchase order.

For additional information regarding this notice, please contact your Renesas sales representative.

Appendix

Changing Point

The assembly site, and Final-Test site are added as follows:

(Continues the production at current site and supports in parallel production)

Changing items	Current	After change	Impact
Assembly site	Assembly site:	Additional site:	Part number: No change
addition	SPIL	ASE-KH	Material: Change
			Mark: Change (Lot# only)
			Outline dimensions: No change
			Machine: Change
			Product characteristics and quality:
			Equivalent
Final test site	FT site:	Additional site:	Machine: No change
addition	KYEC	TeraPower	Test specification: No change
			Packing specifications: No change

Package marking

The assembly site can be identified through the assembly lot number.

Current site: YYWWEVXXXM

Additional site: YYWWKCXXX

